# Battery Main Switch Infineon Technologies AG ATV SYS SE Werner Roessler









- System Overview and Requirements
- Relay = ideal Component?
- Semiconductor Selection
- Reference Design development
- Precharging
- Conclusion

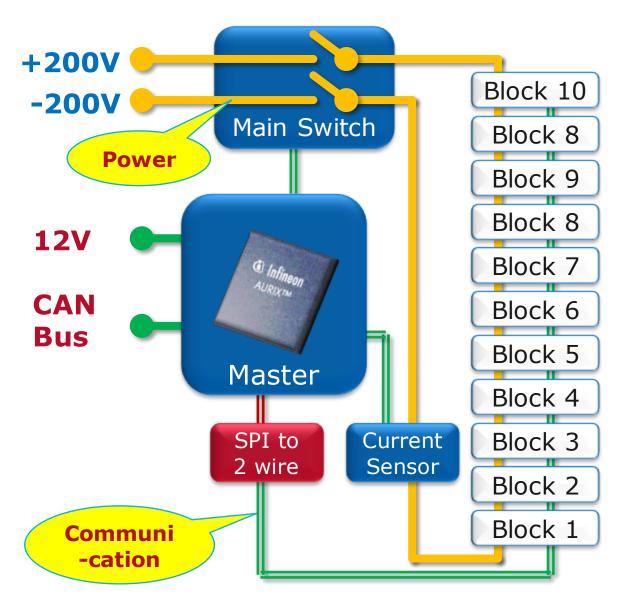


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#### **Battery System**



#### Main Switch Requirements





- Safe Disconnection
- Voltage: 200 500V
- Charge Current:
  - □ Continuous 100A
  - □ Peak (10s): 250A
- Load Current:
  - □ Continuous 150A
  - □ Peak (10s) 350A









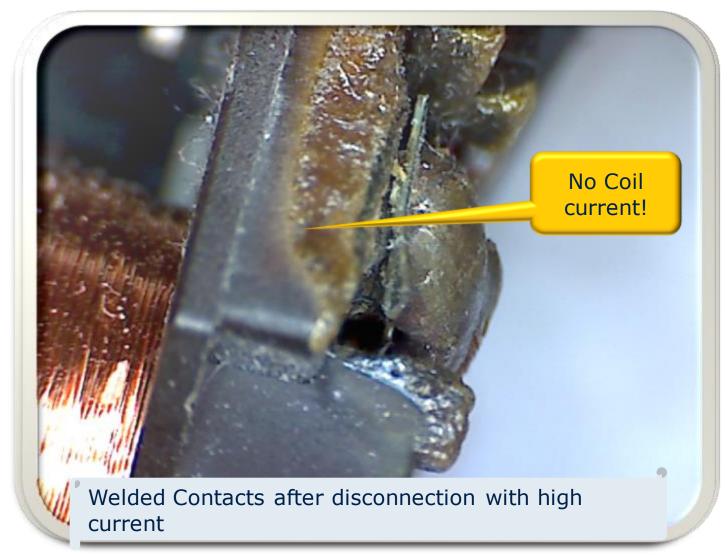


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#### Relay Arcing





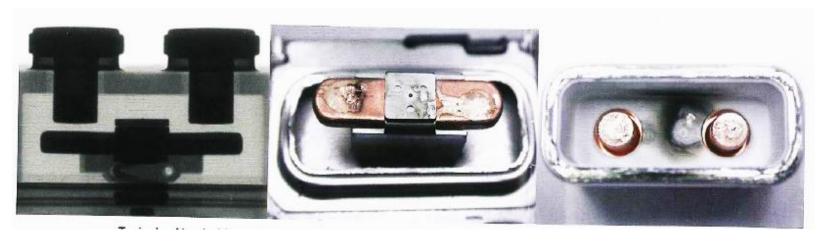






#### Relay – a real ideal switch?

- Contact aging after switch-off (210V / 205A)
  - $\square$  R<sub>on</sub> = really  $0\Omega$  ?
- Condensation of vaporized metal parts at the wall
  - $\square$  Isolation resistance really  $\infty$ ?



Source: Panasonic

#### Relay or Semiconductor-What is better?



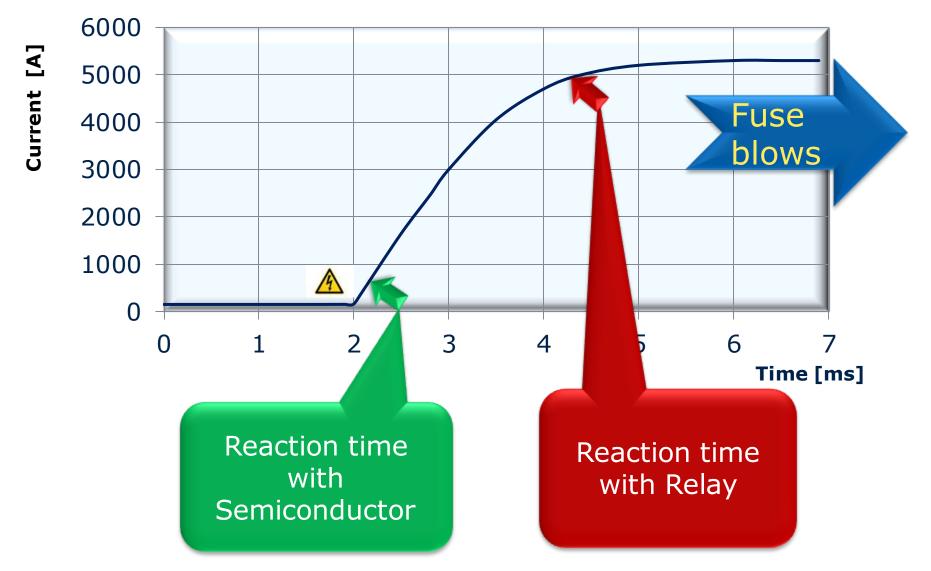


	Relay 🎒	Semiconductor 🧳
Lifetime		
Reaction time		
Efficiency		
Module weight		
Module height		
<b>Component Cost</b>		
System Cost		
Experience		
Vibration robustness		
Noise		

## Main Switch Current rise after Short Circuit







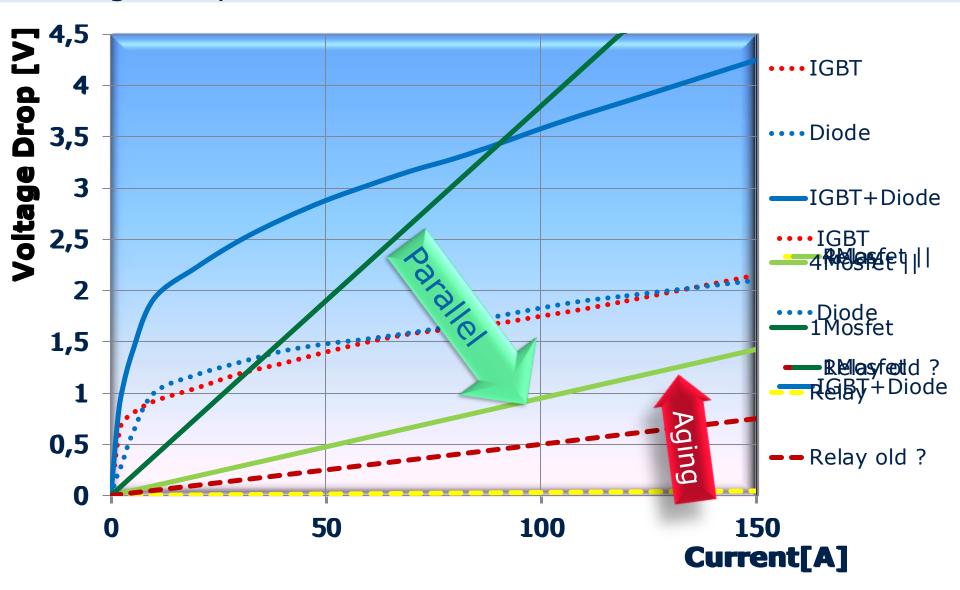


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# Switching Elements Voltage Drop over Current







### MosFET Evolution Better Ron Resistance

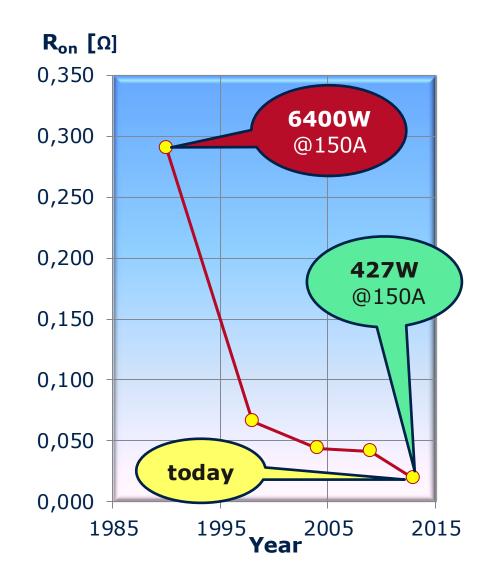




■ Improvement factor 15 within 20 years

Assumption: available silicon chip technology in the actual
 TO247 package device





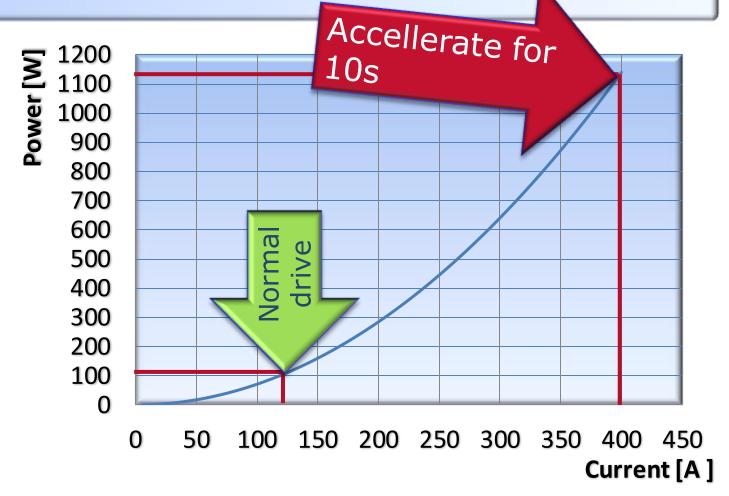
#### **Power Dissipation**





Configuration 8P/3S (8 MosFets parallel and 3 in series)







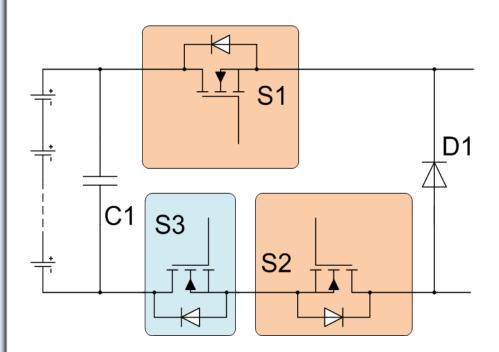
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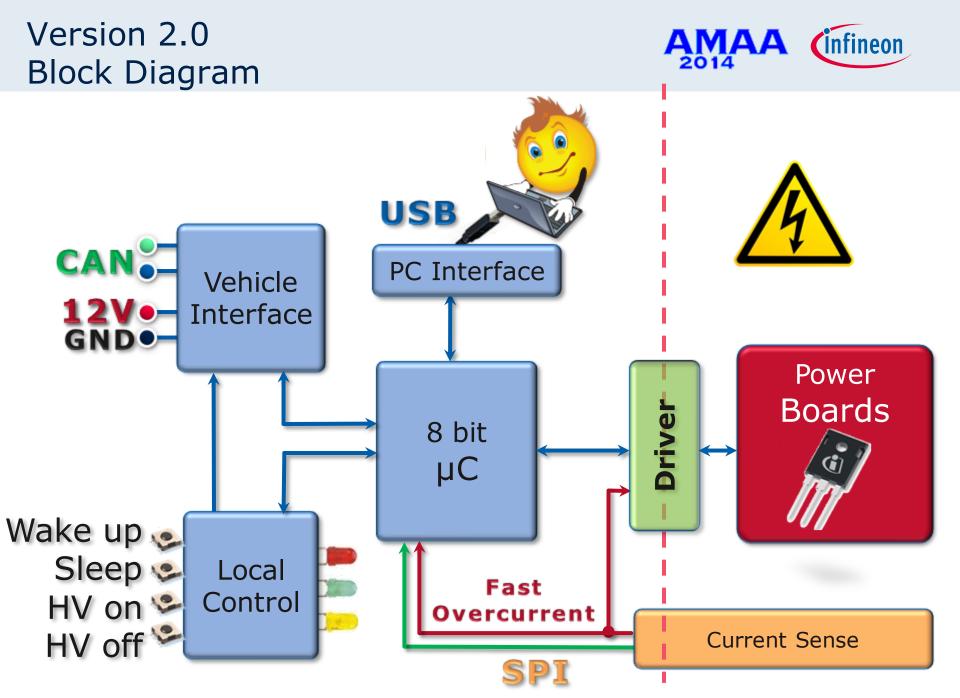
#### **Block Circuit**





- **S1** 
  - □ Voltage disconnect
- **S2** 
  - □ Voltage disconnect (redundant)
- **S3** 
  - Prevent from overcharge (only in charger fail mode)
- **D1** 
  - Free Wheel diode for emergency switch-off
- **C1** 
  - Input Buffer

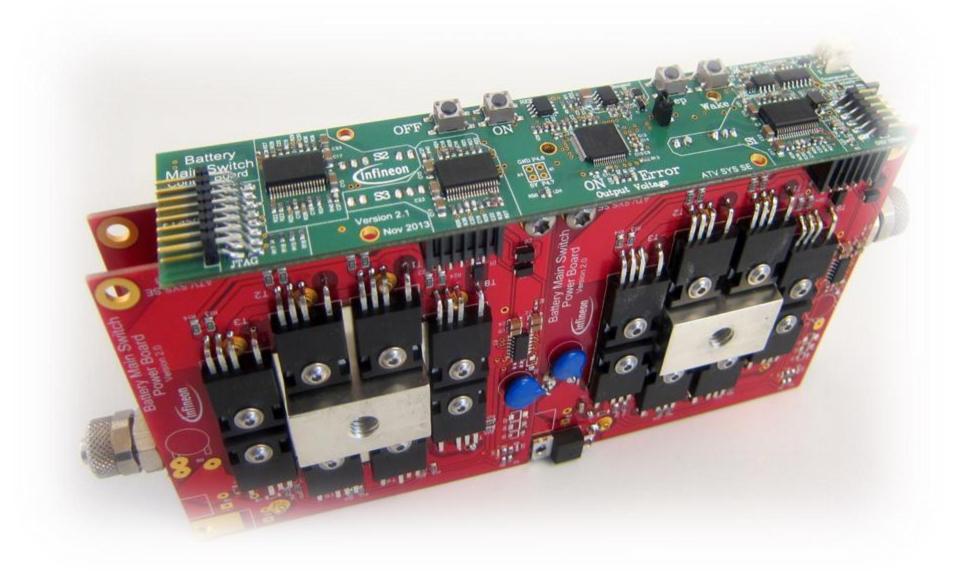
















#### Overload Handling

- Normal Operation (<400A):</p>
  - □ 8 equal independent paths via Hall sensor
    - Check of current distribution possible
  - Board Temperature Measurement



- Overload Condition:
  - □ Fast Overcurrent in Hall Sensors
    - 3µs delay
    - 55A Threshold each > 440A in total
    - Interrupt in μC
    - Hardware Reset of Driver
  - □ Voltage drop over RDSon
    - Hardware switch-off
    - Threshold:
      - -650A @ 25°C
      - -400A @ 120°C



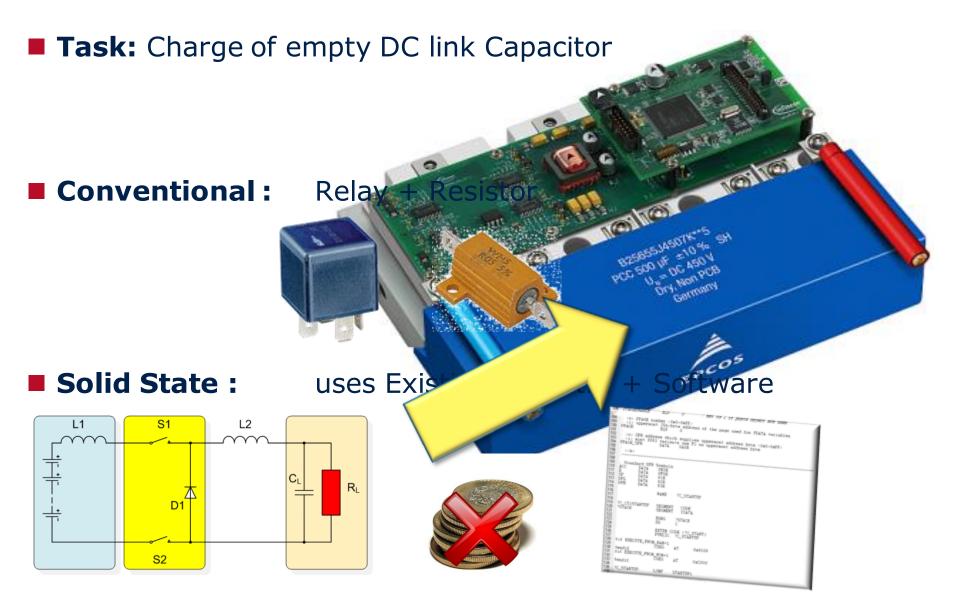


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#### **Precharge Function**



#### Precharge Features





- Detection of
  - Short Circuit
  - Open Load
- Measurement of
  - Load current
  - □ Capacitance value of DC link



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#### Legal Situation LV123



- Past: Two Relays mandatory as safety part; No semiconductors allowed
- Actual proposal: One Relay for final interruption necessary
- **Future**: Complete solid state solution under discussion







#### Savings in the System

- Mechanical Parameters
  - □ Size
  - Weight
- Parts
  - Relays
  - Fuse
  - □ Precharge Circuit
- Wiring diameter
- Noise Cancellation
- Replacement of Switchbox (and Batteries?) after Crash



# ENERGY EFFICIENCY MOBILITY SECURITY

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